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# /!\ REMINDERS

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Please note that Taiyo Yuden Co., Ltd. shall not be responsible for any defects in products or equipment incorporating such products, which are caused under the conditions other than those specified in this catalog or individual specification.

- Please contact Taiyo Yuden Co., Ltd. for further details of product specifications as the individual specification is available.
- Please conduct validation and verification of products in actual condition of mounting and operating environment before commercial shipment of the equipment.
- All electronic components or functional modules listed in this catalog are developed, designed and intended for use in general electronics equipment.(for AV, office automation, household, office supply, information service, telecommunications, (such as mobile phone or PC) etc.). Before incorporating the components or devices into any equipment in the field such as transportation,( automotive control, train control, ship control), transportation signal, disaster prevention, medical, public information network (telephone exchange, base station) etc. which may have direct influence to harm or injure a human body, please contact Taiyo Yuden Co., Ltd. for more detail in advance.

Do not incorporate the products into any equipment in fields such as aerospace, aviation, nuclear control, submarine system, military, etc. where higher safety and reliability are especially required.

In addition, even electronic components or functional modules that are used for the general electronic equipment, if the equipment or the electric circuit require high safety or reliability function or performances, a sufficient reliability evaluation check for safety shall be performed before commercial shipment and moreover, due consideration to install a protective circuit is strongly recommended at customer's design stage.

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# コモンモードチョークコイル (DC、信号ライン用)リードタイプ

COMMON MODE CHOKE COILS (FOR DC AND SIGNAL LINES)

LEADED TYPE

OPERATING TEMP.

TLFタイプ:−25~+115℃ CMタイプ:-25~+105℃

製品自己発熱含む (Including self-generated heat)

CM□RA/BU08RA CM08RB Type 2Lines Type CM05RB Type CM08RB 4Lines Type 4-100-0 100-7 6 5 2 3 4 等価回路 3 4 3 3||6 9 600 Equivalent circuits 9 9



# フロー/WAVE

#### 特長 FEATURES

- ·小形軽量、高信頼性
- ・基板への実装が容易

- · High reliability, compact and lightweight
- · Easily inserted into the PCB

#### 用途 **APPLICATIONS**

- ・TLFタイプ:低周波 (AM放送波)帯域のノイズ対策 (多機能電話機、PBX,FAX等不要輻射電界及び放送波に対する イミュニティ対策)
- ・CM,BUタイプ:高周波 (MHz)帯域のノイズ対策

- · TLF Type: Countemeasure for noise in the low-frequency (AM) broad-casting band. Shields against radiated emissions in the broadcasting frequency for multi-functional telephone sets. PBXs, faxes, etc.
- · CM/BU Type: Countermeasure for noise in the high-frequency (MHz) band

#### 形名表記法 **ORDERING CODE**

TLF Type

a

形式 TLF ラインフィルタ 3

形状 UB△ U字コア分割巻縦形 UBH U字コア分割巻横形 4

302

203

203

公称インダクタンス (μH) 例

3000

20000

6

インダクタンス許容差(%)

コアの長辺寸法 (mm)

△9

当社管理記号 標準品

Type Line filter

Shape U core, vertically split wound UBH U core, horizontally split wound △=Blank space

Nominal inductance ( µ H) example 302 3000

20000

Inductance tolerance (%)

Dimensions of core (mm)

△=Blank space

Internal code

Standard product △=Blank space

### CM-BU Type

a 形式 CM コモンモードチョークコイル BU

コアの寸法 (mm) 05 4.8 08 8.0 12.0

3 形状 複線リード直出し RA ベース使用ピンタイプ RB

試作番号  $01 \sim 20$  当社管理記号 標準品

6



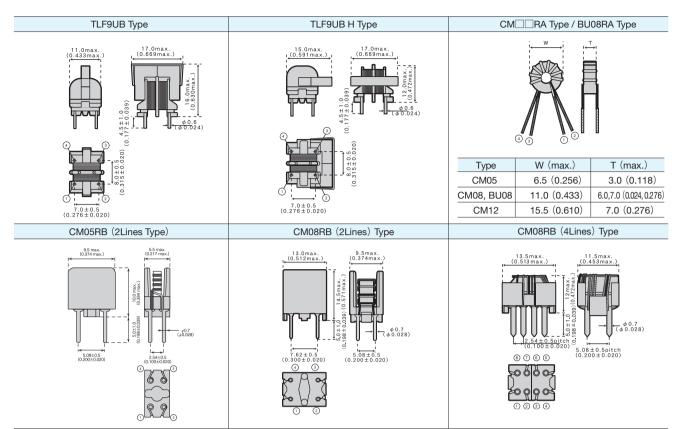
Туре СМ Common mode choke coile BU

Core dimensions (mm) 05 4.8 12 12.0

Shape RA Double-wire lead RB Pin type with base

Product classification code 01~20

Internal code Standard product △=Blank space



Unit: mm (inch)

## アイテム一覧 PART NUMBERS

形名 Ordering code	EHS (Environmental Hazardous Substances)	ライン数 No. of lines	インダクタンス Inductance 〔μΗ〕 〔+100 %〕	直流抵抗 〔Ω〕DC resistance (max.)	定格電流〔A〕 Rated current (max.)		lancolation	インピーダンス〔KΩ〕 参考値 Impedance (Reference values)
TLF9UBH302W	RoHS		3000	1 5	0.4			≧20 (at 1MHz)
TLF9UB 302W	RoHS		3000	1.5	0.4			
TLF9UBH802W	RoHS	2	8000	3.0	0.3	50	100	≥40 (at 700kHz)
TLF9UB 802W	RoHS	2	3000	5.0	0.3	50	100	=40 (at 700KHZ)
TLF9UBH203W	RoHS		20000	6.5	0.18			≥150 (at 500kHz)
TLF9UB 203W	RoHS		20000	0.5	0.10			= 130 (at 300ki iz)

形: Orderin		EHS (Environmental Hazardous Substances)	ライン No.of lines	インダクタンス〔μH〕 Inductance 〔at 1kHz〕	インピーダンス (Ω) Impedance (typical)	直流抵抗〔Ω〕 DC resistance (max.)	定格電流 [A] Rated current (max.)	定格電圧〔V〕 Rated voltage D.C.	絶縁抵抗〔MΩ〕 Insulation resistance (min.)
CM05RA	06	RoHS		0.7min	700(at 200MHz)	0.050	1.5		
BU08RA	11	RoHS		0.7~1.3	1000(at 250MHz)	0.013	4.0		
DUUONA	16	RoHS		1.19~2.21	1200 (at 200MHz)	0.011	3.0		
CMOODA	17	RoHS		15.0min	2000(at 80MHz)	0.040	2.4		
CM08RA	20	RoHS		6.0min	500 (at 200MHz)	0.020	5.5		
CM12RA	02	RoHS	2	10.0min	2000(at 80MHz)	0.040	3.0	50	100
CMOEDD	01	RoHS		7.0min	700(at 70MHz)	0.050	2.0	50	100
CM05RB	03	RoHS		15.0min	1400 (at 100MHz)	0.060	1.5		
	01	RoHS		40.0min	2500(at 30MHz)	0.040	2.0		
	02	RoHS		15.0min	2000(at 50MHz)	0.040	2.4		
CM08RB	04	RoHS		110.0min	2000(at 70MHz)	0.040	3.0		
	05	RoHS		6.0min	450 (at 100MHz)	0.020	4.0		
	03	RoHS	4	15.0min	1000(at 50MHz)	0.050	2.0		

セレクションガイド Selection Guide

₹ P.14

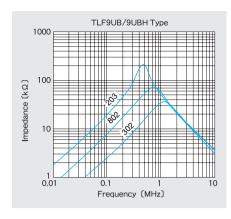


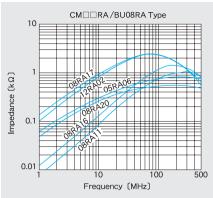
特性図 **Electrical Characteristics** 

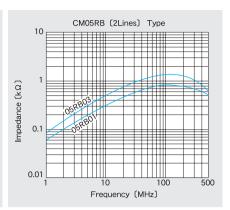


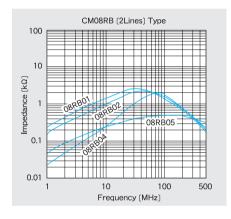


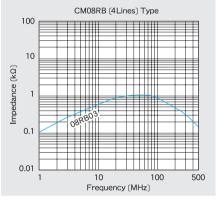












## (測定条件) Measuring conditions

使用測定器 Equipment : HP 4291A Vosc: 0.5V (CM/BU type) HP 4192A Vosc: 0.35V(TLF type)

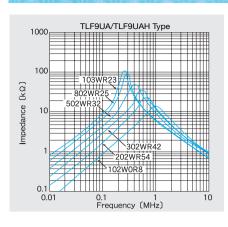
測定回路 Measuring circuit

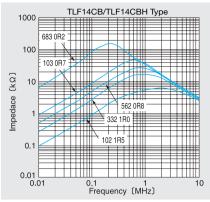


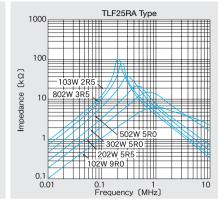
アナライザーへ

ピーダンス To impedance analyzer

## インピーダンス一周波数特性 IMPEDANCE-FREQUENCY CHARACTERISTIC







(測定条件)

使用測定器: HP-4192A

Vosc-0.35V

測定回路

W ത

インピーダンス アナライザーへ

Test conditions

Test circuit

Equipment: HP-4192A

Vosc-0.35V

To impedance analyzer

#### **PACKAGING** 梱包

最小受注単位数 Minimum Quantity

CM / BU Type

	最小受注単位数(pcs.)				
Tuna	Minimum	Quantity			
Type	箱づめ	袋づめ			
	Box	Bulk			
CM05RA06	_	500			
CM05RB□□	1000	_			
CM08RA□□	_	250			
CM08RB□□	500	_			
CM12RA02	_	100			
BU08RA	_	200			

TI F Type

	i Li Type							
		最小受注単位数 (pcs.)						
т	Туре	Minimum Quantity						
	туре	箱づめ						
		Box						
TLF9UA□		500						
TLF9UB□		500						
	TLF14CB□	500						
	TLF25RA	200						

		Specific	ed Value				
Item					Test method and r	emarks	
	CM-RA/ BU-RA Type	CM-RB Type	TLF9U TLF14CB	TLF25RA			
1.Operating Temperature	-25~+105°C		TLF9U: -25~+115℃	-25~+105°C		16	4l b4
Range			TLF14CB: -20~+105°C		Including temperature rise due to	seit-generai	ted neat.
2.Storage temperature range	-40~+85°C						
3.Rated current	Within the specifed rang	je			CM:		
					The maximum DC value having		
					within specified temperature, as	detailed in	individual
					specification.		
					TLF9UA, 14CB, 25RA:		
					The maximum AC value having	temperature	increase
					within 45°C by the application of A	AC current.	
					TLF9UB:		
					The maximum DC value having	temperature	increase
					within 45°C by the application of E	OC current.	
4.Inductance	Within the specifed tole	rance			CM:		. I I
					Measuring equipmet : 4262A (HP Measuring frequency : 1kHz	) or its equiv	raient
					TLF9U, 25RA:		
					Measuring equipment : Impedance		HP4192A)
					or its equiv	/aient	
					Measuring voltage : 0.35Vosc		
					TLF14CB:	10011	
					Measuring equipment : LCR mete Measuring frequency : 1kHz	r 4284A or its	equivalent
					Measuring voltage : 1.0V		
5.DC resistance	Within the specifed tole	rance			CM, TLF:		
					Measuring equipment : DC ohmm	neter	
6.Terminal strength tensile force	No abnormality				CM: Fix the component in the direct	tion to draw	v terminal
terialie force					and gradually apply tensile force		
					specifications.		
					TLF9U:		
					Apply the stated tensile force gra	adually in the	e direction
					to draw terminal.	,	
					Nominal wire diameter tensile $\phi$ d	force	duration
					(mm)	(N)	(S)
					φ 0.6  TLF14CB:	5	30±5
					Apply the stated tensile force gra	adually in the	e direction
					to draw terminal.		
					Nominal wire diameter tensile φ d (mm)	force (N)	duration (S)
					φ0.8	10	30±5
					TLF25RA:		
					Apply the tensile force of 10N in	the directio	n to draw
7 Tomporaturo rico	Refer to individual speci	fication	45℃ max.		terminal for 5 seconds.		
7.Temperature rise	Tioler to individual spec	nouton	TO MIGA.		Resistance substitution method		
					Applied current : Rated current		
					Duration: 1 hr		
8.Insulation resistance between wires	100MΩmin.				CM • TLF : Applied voltage : Rated voltage (CM-I	DA/BLL DA C	M DD)
between wiles					: 500VDC (TLF9UA		
					: 250VDC (TLF 9 U		
O Inquisting			T		Duration: 60sec.		
9.Insulation resistance between wire and core			100MΩmin.		TLF:	IA 14CB)	
22.1100.1 W. G and Gold					Applied voltage: 500VDC (TLF9U): 250VDC (TLF 9U)		
					Duration : 60 sec.	<u>.</u>	

		Specific	ed Value		
ltem	CM-RA/ BU-RA Type	CM-RB Type	TLF9U TLF14CB	TLF25RA	Test method and remarks
10.Withstanding: between wires	No abnormality				CM · TLF : Applied voltage : 250VDC (CM-RA/BU-RA, CM-RB) : 2000VAC (TLF9UA, 14CB, 25RA) : 500VDC (TLF 9 UB) Duration : 60sec.
11.Withstanding:			No abnormality		TLF:
between wires and core					Applied voltage: 2000VAC (TLF9UA, 14CB) : 500VDC (TLF9UB)  Duration: 60sec.
12.Rated voltage	Within the specified ran	ge			TLF9UA, 14CB, 25RA: 250VAC TLF9UB: 50VDC
13.Resistance to vibration	At least 75% of terminal	Appearance : No abnormality Inductance change : Within±15%	TLF9U Inductance change : Within±5%  TLF14CB Within the specified range	mly adhered onto im-	CM, TLF: According to JIS C0040 Direction: 2hrs each in X, Y and Z direction Total: 6hrs Frequency range: 10 to 55 to 10Hz (1 min.) Amplitude: 1.5mm (shall not exceed acceleration 196m²/s) Mounting method: soldering onto PC board Recovery: 2 to 24 hrs of recovery under the standard condition after the test. (CM—RB) : At least 1hr of recovery under the standard condition after the removal from test chamber, followed by the measurement within 2hrs. (TLF9U, 14CB)
14.Solderability	new solder.	al electrode is covered by	mersed surfaces.	mly adhered onto im-	CM: Solder temperature: 235±5°C  Duration: 2±0.5sec.  Immersion depth: According to detailed specification.  TLF: Solder temperature: 230±5°C  Duration: 2±0.5sec. (9U、25RA) : 3±0.5sec. (14CB)  Immersion depth: Up to 1.0 to 1.5mm from PBC mounted level.
15.Resistance to soldering	Appearance : No abnor	rmality Refer to individual specifi-	TLF9UA • TLF25RA : Inductance change : Wi	ithin±5%	CM: Solder temperature: 260±5°C
heat	cation cation	теге то погодат урести	TLF14CB Within the specified range		Duration: 5±0.5sec. Immersion depth: Up to 2~2.5mm from terminal root. Recovery: 1 to 2 hrs of recovery under the standard condition after the test.  TLF: Solder temperature: 260±5°C Duration: 5±1sec. (25RA) : 10±1sec. (9U, 14CB) Immersion depth: Up to 1.0 to 1.5mm from PBC mounted level. Recovery: At least 1hr of recovery under the standard condition after the removal from test chamber, followed by the measurement within 2hrs.

		Specifie	d Value				
ltem	CM—RA/ BU—RA Type CM—RB Type		TLF9U TLF14CB	TLF25RA	Test method and remarks		
16.Thermnal shock	Appearance : No abnor	mality lefer to individual specifi-	TLF9UA • TLF25RA : Inductance change : W  TLF14CB : • Withstanding voltage • Insulation resistance :	No abnormality		or 1 cycle Temperature (°C) -25±3 Room Temperature +85±2 Room Temperature	oval from test chamber,
17.Damp heat			TLF9UA · TLF25RA :		TLF:		
			Inductance change: W TLF14CB: Withstanding voltage: Insulation resistance: N	No abnormality	Temperature  **TLF14CB  Humidity: 90  Duration: 50  Recovery: re	Temperature:40±2°C 0~95%RH	y under the standard
18. Loading under damp heat	Appearance : No abnor Inductance change : F cation	mality lefer to individual specifi-	Withstanding voltage: Insulation resistance: N		CM: Temperature Humidity: 90 Duration: 50 Applied curre Recovery:  TLF: Temperature %TLF14CB Humidity: 90 Duration: 10 Applied volta  TLF9UA TLF9UE	: 40±2°C 0~95%RH 10 (+12, -0) hrs ent: Rated current 1 to 2hrs of recovery undition after the removal  : 60±2°C Temperature: 40±2°C 0~95%RH 10 hrs age: Apply the follow between windin 1. 25RA 250VAC	nder the standard con- from test chamber.  wing specified voltage gs.  Apply rated current
19.Loading at high temperature			Withstanding voltage : tion resistance : No abr	No abnormality Insula- normality	TLF: Temperature Duration: 10 Applied volta  TLF9UA TLF9UE	At least 1hr of recover emoval from test char neasurement within 2 h  85±2°C  10 hrs  age : Apply the follow between windin  258A 250VAC	y under the standard inber followed by the irs.
					Apply rated of Recovery	current across windings At least 1hr of recove	ry under the standard amber followed by the

4/4

		Specifie	d Value		
ltem	CM-RA/ BU-RA Type	CM—RB Type	TLF9U TLF14CB	TLF25RA	Test method and remarks
20.Low temperature life test	Appearance : No abnor	mality	TLF9U • TLF25RA :		CM:
, , , , , , , , , , , , , , , , , , , ,	Inductance change : F	efer to individual specifi-	Inductance change: W	thin±15%	Temperature: -40±3°C Duration: 500 (+12, -0) hrs
			TLF14CB: Withstanding voltage: Insulation resistance:		Recovery: 1 to 2hrs of recovery under the standard condition after the removal from test chamber.  (CM-RA)  1 to 2hrs of recovery under the standard condition after the removal from test chamber.  (CM-RB)
					TLF: Temperature: -25±2°C  **TLF14CB Temperature: -40±2°C  Duration: 500 hrs  Recovery: At least 1hr of recovery under the standard removal from test chamber followed by the measurement within 2 hrs.
21.High Temperature life test	Appearance : No abnor	mality	TLF9U • TLF25RA :		CM:
3 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1		efer to individual specifi-	Inductance change : W	ithin±15%	Temperature: 85±2°C Duration: 500 (+12, -0) hrs
			TLF14CB:		Recovery : 1 to 2hrs of recovery under the standard con-
			Withstanding voltage:     Insulation resistance:		dition after the removal from test chamber.  (CM-RA)  : 1 to 2hrs of recovery under the standard condition after the removal from test chamber.  (CM-RB)
					TLF: Temperature: 85±2°C  **TLF14CB Temperature: 105±3°C  Duration: 500 hrs  Recovery: At least 1hr of recovery under the standard
					removal from test chamber followed by the measurement within 2 hrs.

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#### CM-RA Type CM-RB Type TI F Type

Stages	Precautions	Technical considerations
1.Circuit Design	Operating environment,	
	1.The products described in this specification are intended for	
	use in general electronic equipment, (office supply	
	equipment, telecommunications systems, measuring	
	equipment, and household equipment). They are not	
	intended for use in mission-critical equipment or systems	
	requiring special quality and high reliability (traffic systems,	
	safety equipment, aerospace systems, nuclear control	
	systems and medical equipment including life-support	
	systems,) where product failure might result in loss of life,	
	injury or damage. For such uses, contact TAIYO YUDEN	
	Sales Department in advance.	
P.PCB Design	Design	1. When Inductors are mounted onto a PC board, hole dimensions on the board sho
	1.Please design insertion pitches of a base in the pitches that	match the lead pitch of the component, if not, it will cause breakage of the termin
	fitted a terminal interval.	or cracking of terminal roots covered with resin as excess stress travels through t
		terminal legs.
3.Soldering	Wave soldering	
	1.Please refer to the specifications in the catalog for a wave	
	soldering.	
	2.Do not immerse the entire Inductors in the flux during the	
	soldering operation.	
	Lead free soldering	
	1. When using products with lead free soldering, we request to	1.If products are used beyond the range of the recommended conditions, heat stress
	use them after confirming of adhesion, temperature of	may deform the products, and consequently degrade the reliability of the products
	resistance to soldering heat, etc. sufficiently.	
	Recommended conditions for using a soldering iron	
	Put the soldering iron on the land-pattern.	
	Soldering iron's temperature - Below 350 °C	
	Duration - 3 seconds or less	
	The soldering iron should not directly touch the product.	
.Cleaning	Cleaning conditions	
Ü	1.TLF type	
	Please contact any of our offices for about a cleaning,	
5.Handling	Handling	
Ü	1.Keep the product away from all magnets and magnetic	1.There is a case that a characteristic varies with magnetic influence.
	objects.	
	Mechanical considerations	
	1.Please do not give the product any excessive mechanical	1.There is a case to be damaged by a mechanical shock.
	shocks.	Times to a sace to be damaged by a moonamen choose
	2.TLF type	2.TLF type
	Please do not add any shock or and power to a product in	There is a case to be broken by a fall.
		There is a case to be broken by a fail.
	transportation.	
	Packing	1 There is a good that a load value turns at by a fall as an even size a shock
	1.Please do not give the product any excessive mechanical	1.There is a case that a lead route turns at by a fall or an excessive shock.
	shocks.	
	In loading, please pay attention to handling indication	
	mentioned in a packing box (a loading direction / number of	
Ctorogolia'	maximum loading / fragile item).	
.Storage conditions	Storage	
	1.To maintain the solderability of terminal electrodes and to	Under a high temperature and humidity environment, problems such as reduce
	keep the packing material in good condition, temperature	solderability caused by oxidation of terminal electrodes and deterioration
	and humidity in the storage area should be controlled.	taping/packaging materials may take place.
	*Recommended conditions	
	Ambient temperature 0~40°C	
	Humidity Below 70% RH	
	The ambient temperature must be kept below 30°C. Even	
	under ideal storage conditions, solderability of products	
	electrodes may decrease as time passes. For this reason,	
	product should be used within one year from the time of	
	delivery.	
	In case of storage over 6 months, colderability shall be	
	In case of storage over 6 months, solderability shall be	